

STX83003

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- ST83003 SILICON IN TO-92 PACKAGE
- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

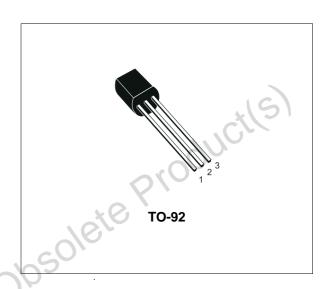
APPLICATIONS:

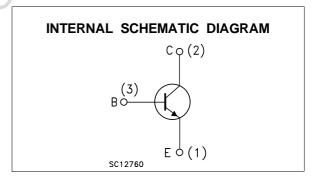
 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING

DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STX83003 is expressly designed for a new solution to be used in compact fluorescent lamps, where it is coupled with the STX93003, its complementary PNP transistor.





ABSOLUTE MAXIMUM RATINGS

olete Pr

Symbol	Parameter	Value	Unit
Vces	Collector-Emitter Voltage (V _{BE} = 0)	700	V
V_{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V
V _{EBO}	Emitter-Base Voltage ($I_C = 0$, $I_B = 0.5$ A, $t_p < 10\mu s$, $T_j < 150$ °C)	V _(BR) ebo	V
Ic	Collector Current	1	Α
I _{CM}	Collector Peak Current (t _p < 5 ms)	3	Α
Ι _Β	Base Current	0.5	Α
I _{BM}	Base Peak Current (t _p < 5 ms)	1.5	Α
P _{tot}	Total Dissipation at T _C = 25 °C	1.5	W
T _{stg}	Storage Temperature	-65 to 150	O°
Tj	Max. Operating Junction Temperature	150	°C

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THERMAL DATA

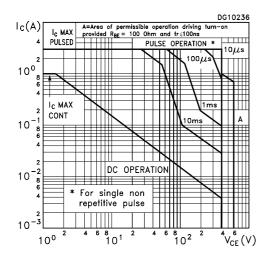
R _{thj-case}	Thermal Resistance Junction-Case	Max	83.3	°C/W	
$R_{thj-amb}$	Thermal Resistance Junction-Ambient	Max	200	°C/W	

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

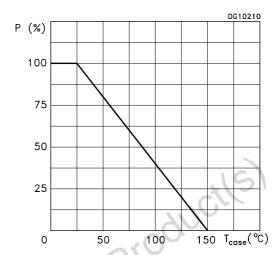
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 700V V _{CE} = 700V	$T_{j} = 125^{\circ}C$			1 5	mA mA
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 10 mA		12		18	>
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 10 mA L = 25 mH		400		Cil	\
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 0.5 A I _C = 0.35 A	$I_B = 0.1 A$ $I_B = 50 \text{ mA}$	~ ()	00/	0.5 1	V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 0.5 A	I _B = 0.1 A	7		1	V
h _{FE} *	DC Current Gain	I _C = 10 mA I _C = 0.35 A I _C = 1 A	$V_{CE} = 5 V$ $V_{CE} = 5 V$ $V_{CE} = 5 V$	10 16 4	25	32	
t _r t _s t _f	RESISTIVE LOAD Rise Time Storage Time Fall Time	$I_{C} = 0.35 \text{ A}$ $I_{B1} = 70 \text{ mA}$ $T_{p} \ge 25 \mu\text{s}$	$V_{CC} = 125 V$ $I_{B2} = -70 \text{ mA}$ (see figure 2)	1.5	100 2.2 0.2	2.9	ns µs µs
t _s	INDUCTIVE LOAD Storage Time Fall Time	I _C = 0.5 A V _{BE(off)} = -5 V V _{clamp} = 300 V	$I_{B1} = 0.1 A$ L = 10 mH (see figure 1)		450 90		ns ns

^{*} Pulsed: Pulse duration = 300μs, duty cycle = 1.5 %.

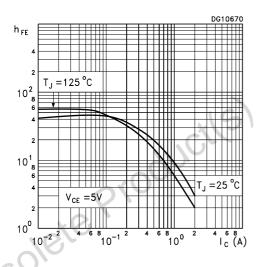
Safe Operating Area



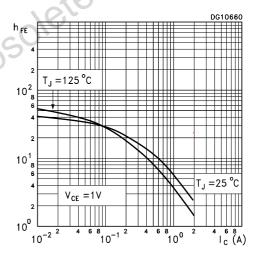
Derating Curve



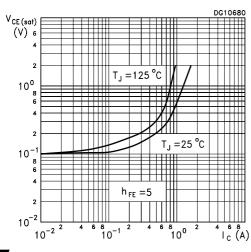
DC Current Gain



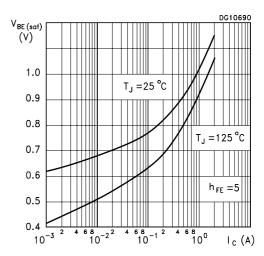
DC Current Gain



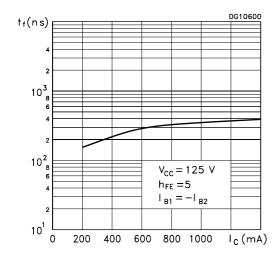
Collector Emitter Saturation Voltage



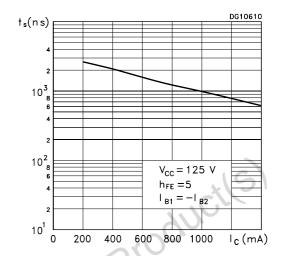
Base Emitter Saturation Voltage



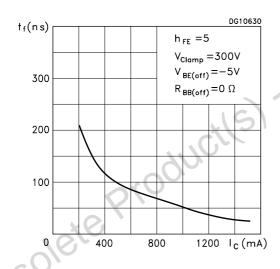
Resistive Load Fall Time



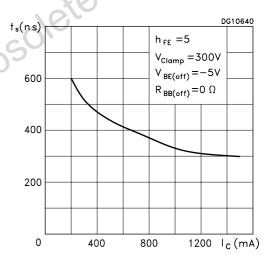
Resistive Load Storage Time



Inductive Load Fall Time



Inductive Load Storage Time



Reverse Biased SOA

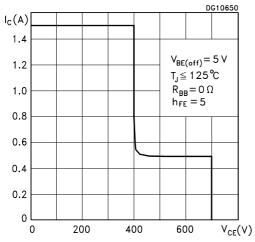


Figure 1: Inductive Load Switching Test Circuit.

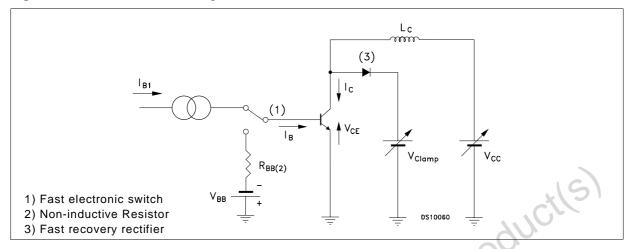
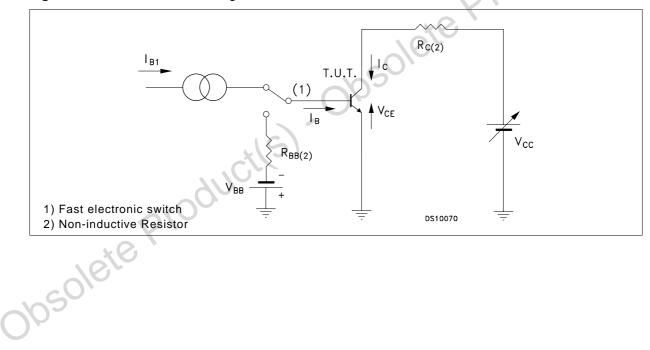
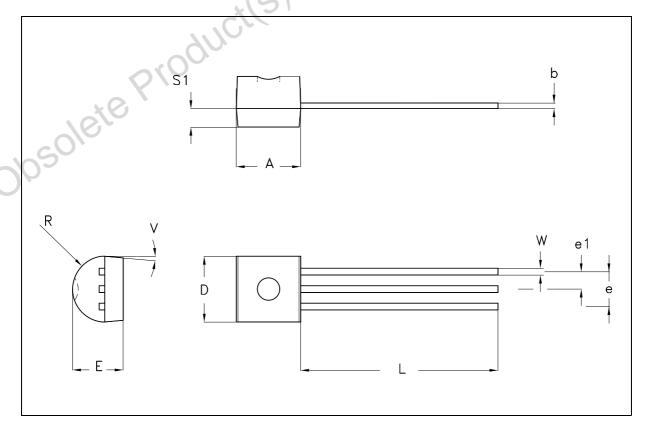


Figure 2: Resistive Load Switching Test Circuit.



TO-92 MECHANICAL DATA

DIM.	mm			inch			
2	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.32		4.95	0.170		0.195	
b	0.36		0.51	0.014		0.020	
D	4.45		4.95	0.175		0.194	
Е	3.30		3.94	0.130		0.155	
е	2.41		2.67	0.095	111	0.105	
e1	1.14		1.40	0.045	~ * OO	0.055	
L	12.70		15.49	0.500	2/-	0.609	
R	2.16		2.41	0.085		0.094	
S1	1.14		1.52	0.045		0.059	
W	0.41		0.56	0.016		0.022	
V	4 degree		6 degree	4 degree		6 degree	



Obsolete Product(s). Obsolete Product(s)

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